

# CDx4AC00 Quadruple 2-Input Positive-nand Gates

## 1 Features

- AC types feature 1.5V to 5.5V operation and balanced noise immunity at 30% of the supply voltage
- Speed of bipolar F, AS, and S, with significantly reduced power consumption
- Balanced propagation delays
- $\pm 24\text{mA}$  output drive current
  - Fanout to 15 F devices
- SCR-latchup-resistant CMOS process and circuit design
- Exceeds 2kV ESD protection per MIL-STD-883, method 3015

## 2 Description

The 'AC00 devices contain four independent 2-input NAND gates. Each gate performs the Boolean function of  $Y = \overline{A} \cdot \overline{B}$  or  $Y = \overline{A + B}$  in positive logic.

### Device Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> | BODY SIZE <sup>(3)</sup> |
|-------------|------------------------|-----------------------------|--------------------------|
| CDx4AC00    | D (SOIC, 14)           | 8.65mm × 6mm                | 8.65mm × 3.9mm           |
|             | N (PDIP, 14)           | 19.3mm × 9.4mm              | 19.3mm × 6.35mm          |
|             | J (CDIP, 14)           | 19.56mm × 7.9mm             | 19.56mm × 6.67mm         |

- For more information, see [Section 10](#).
- The package size (length × width) is a nominal value and includes pins, where applicable.
- The body size (length × width) is a nominal value and does not include pins.



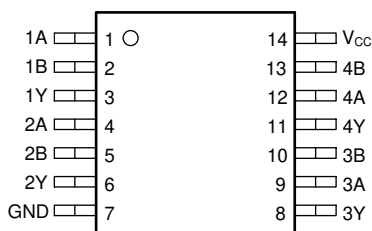
Logic Diagram, Each Gate (Positive Logic)



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## 3 Pin Configuration and Functions



**Figure 3-1. CD54AC00 J Package, 14-Pin CDIP; CD74AC00 D or N Packages, 14-Pin SOIC, or PDIP (Top View)**

| PIN |                 | TYPE <sup>1</sup> | DESCRIPTION |
|-----|-----------------|-------------------|-------------|
| NO. | NAME            |                   |             |
| 1   | 1A              | I                 | 1A Input    |
| 2   | 1B              | I                 | 1B Input    |
| 3   | 1Y              | O                 | 1Y Output   |
| 4   | 2A              | I                 | 2A Input    |
| 5   | 2B              | I                 | 2B Input    |
| 6   | 2Y              | O                 | 2Y Output   |
| 7   | GND             | —                 | GND         |
| 8   | 3Y              | O                 | 3Y Output   |
| 9   | 3A              | I                 | 3A Input    |
| 10  | 3B              | I                 | 3B Input    |
| 11  | 4Y              | O                 | 4Y Output   |
| 12  | 4A              | I                 | 4A Input    |
| 13  | 4B              | I                 | 4B Input    |
| 14  | V <sub>CC</sub> | —                 | Power Pin   |

(1) Signal Types: I = Input, O = Output, I/O = Input or Output.

## 4 Specifications

### 4.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                        |                           | MIN                                                                      | MAX | UNIT   |
|------------------------|---------------------------|--------------------------------------------------------------------------|-----|--------|
| V <sub>CC</sub>        | Supply voltage range      | –0.5                                                                     | 6   | V      |
| I <sub>IK</sub>        | Input clamp current       | (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> ) <sup>(2)</sup> |     | ±50 mA |
| I <sub>OK</sub>        | Output clamp current      | (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) <sup>(2)</sup> |     | ±50 mA |
| I <sub>O</sub>         | Continuous output current | (V <sub>O</sub> = 0 to V <sub>CC</sub> )                                 |     | ±50 mA |
| V <sub>CC</sub> or GND | Continuous current        | ±100                                                                     |     | mA     |
| T <sub>stg</sub>       | Storage temperature range | –65                                                                      | 150 | °C     |

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 4.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                                    |                                  | TA = 25 °C |                 | –40°C TO 85°C |                 | –55°C TO 125°C |                 | UNIT |
|-----------------|------------------------------------|----------------------------------|------------|-----------------|---------------|-----------------|----------------|-----------------|------|
|                 |                                    |                                  | MIN        | MAX             | MIN           | MAX             | MIN            | MAX             |      |
| V <sub>CC</sub> | Supply voltage                     |                                  | 1.5        | 5.5             | 1.5           | 5.5             | 1.5            | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 1.5 V          | 1.2        |                 | 1.2           |                 | 1.2            |                 | V    |
|                 |                                    | V <sub>CC</sub> = 3 V            | 2.1        |                 | 2.1           |                 | 2.1            |                 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V          | 3.15       |                 |               |                 | 3.15           |                 |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V          | 3.85       |                 | 3.85          |                 | 3.85           |                 |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 1.5 V          |            | 0.3             |               | 0.3             |                | 0.3             | V    |
|                 |                                    | V <sub>CC</sub> = 3 V            |            | 0.9             |               | 0.9             |                | 0.9             |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V          |            | 1.35            |               |                 |                | 1.35            |      |
|                 |                                    | V <sub>CC</sub> = 5.5 V          |            | 1.65            |               | 1.65            |                | 1.65            |      |
| V <sub>I</sub>  | Input voltage                      |                                  | 0          | V <sub>CC</sub> | 0             | V <sub>CC</sub> | 0              | V <sub>CC</sub> | V    |
| V <sub>O</sub>  | Output voltage                     |                                  | 0          | V <sub>CC</sub> | 0             | V <sub>CC</sub> | 0              | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 4.5 V to 5.5 V |            | –24             |               | –24             |                | –24             | mA   |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 4.5 V to 5.5 V |            | 24              |               | 24              |                | 24              | mA   |
| Δt/Δv           | Input transition rise or fall rate | V <sub>CC</sub> = 1.5 V to 3 V   |            | 50              |               | 50              |                | 50              | ns/V |
|                 |                                    | V <sub>CC</sub> = 3.6 V to 5.5 V |            | 20              |               | 20              |                | 20              |      |

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

### 4.3 Thermal Information

| THERMAL METRIC <sup>1</sup> |                                        | CD74AC00 |          | UNIT |
|-----------------------------|----------------------------------------|----------|----------|------|
|                             |                                        | D (SOIC) | N (PDIP) |      |
|                             |                                        | 14 PINS  | 14 PINS  |      |
| R <sub>θJA</sub>            | Junction-to-ambient thermal resistance | 119.9    | 80       | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application note](#).

## 4.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                     |                                         | V <sub>CC</sub> | TA = 25°C |      | -40°C TO 85 °C |      | -55 °C TO 125°C |      | UNIT |
|-----------------|-----------------------------------------------------|-----------------------------------------|-----------------|-----------|------|----------------|------|-----------------|------|------|
|                 |                                                     |                                         |                 | MIN       | MAX  | MIN            | MAX  | MIN             | MAX  |      |
| V <sub>OH</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = -50 µA                | 1.5 V           | 1.4       |      | 1.4            |      | 1.4             |      | V    |
|                 |                                                     |                                         | 3 V             | 2.9       |      | 2.9            |      | 2.9             |      |      |
|                 |                                                     |                                         | 4.5 V           | 4.4       |      | 4.4            |      | 4.4             |      |      |
|                 |                                                     | I <sub>OH</sub> = -4 mA                 | 3 V             | 2.58      |      | 2.48           |      | 2.4             |      |      |
|                 |                                                     | I <sub>OH</sub> = -24 mA                | 4.5 V           | 3.94      |      | 3.8            |      | 3.7             |      |      |
|                 |                                                     | I <sub>OH</sub> = -50 mA <sup>(1)</sup> | 5.5 V           |           |      |                |      | 3.85            |      |      |
|                 |                                                     | I <sub>OH</sub> = -75 mA <sup>(1)</sup> | 5.5 V           |           |      | 3.85           |      |                 |      |      |
| V <sub>OL</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OL</sub> = 50 µA                 | 1.5 V           |           | 0.1  |                | 0.1  |                 | 0.1  | V    |
|                 |                                                     |                                         | 3 V             |           | 0.1  |                | 0.1  |                 | 0.1  |      |
|                 |                                                     |                                         | 4.5 V           |           | 0.1  |                | 0.1  |                 | 0.1  |      |
|                 |                                                     | I <sub>OL</sub> = 12 mA                 | 3 V             |           | 0.36 |                | 0.44 |                 | 0.5  |      |
|                 |                                                     | I <sub>OL</sub> = 24 mA                 | 4.5 V           |           | 0.36 |                | 0.44 |                 | 0.5  |      |
|                 |                                                     | I <sub>OL</sub> = 50 mA <sup>(1)</sup>  | 5.5 V           |           |      |                |      |                 | 1.65 |      |
|                 |                                                     | I <sub>OL</sub> = 75 mA <sup>(1)</sup>  | 5.5 V           |           |      |                | 1.65 |                 |      |      |
| I <sub>I</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND             |                                         | 5.5 V           |           | ±0.1 |                | ±1   |                 | ±1   | µA   |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND,            | I <sub>O</sub> = 0                      | 5.5 V           |           | 4    |                | 40   |                 | 80   | µA   |
| C <sub>i</sub>  |                                                     |                                         |                 |           | 10   |                | 10   |                 | 10   | PF   |

(1) Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

## 4.5 Switching Characteristics, V<sub>CC</sub> = 1.5V

over recommended operating free-air temperature range, V<sub>CC</sub> = 1.5V, C<sub>L</sub> = 50pF (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | -40°C TO 85°C |     | -55°C TO 125°C |     | UNIT |
|------------------|--------------|-------------|---------------|-----|----------------|-----|------|
|                  |              |             | MIN           | MAX | MIN            | MAX |      |
| t <sub>PLH</sub> | A or B       | Y           |               | 83  |                | 91  | ns   |
| t <sub>PHL</sub> |              |             |               | 83  |                | 91  |      |

## 4.6 Switching Characteristics, V<sub>CC</sub> = 3.3V ± 0.3V

over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3V ± 0.3V, C<sub>L</sub> = 50pF (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | -40°C TO 85°C |     | -55°C TO 125°C |      | UNIT |
|------------------|--------------|-------------|---------------|-----|----------------|------|------|
|                  |              |             | MIN           | MAX | MIN            | MAX  |      |
| t <sub>PLH</sub> | A or B       | Y           | 2.7           | 9.3 | 2.6            | 10.2 | ns   |
| t <sub>PHL</sub> |              |             | 2.7           | 9.3 | 2.6            | 10.2 |      |

#### 4.7 Switching Characteristics, $V_{CC} = 5V \pm 0.5V$

over recommended operating free-air temperature range,  $V_{CC} = 5V \pm 0.5V$ ,  $C_L = 50pF$  (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

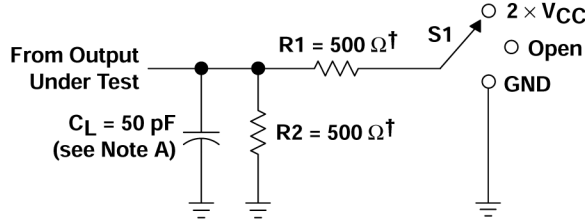
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | –40°C TO 85°C |     | –55°C TO 125°C |     | UNIT |
|-----------|--------------|-------------|---------------|-----|----------------|-----|------|
|           |              |             | MIN           | MAX | MIN            | MAX |      |
| $t_{PLH}$ | A or B       | Y           | 1.9           | 6.6 | 1.8            | 7.3 | ns   |
| $t_{PHL}$ |              |             | 1.9           | 6.6 | 1.8            | 7.3 |      |

#### 4.8 Operating Characteristics

$V_{CC} = 5V$ ,  $T_A = 25^\circ C$

| PARAMETER |                               | TYP | UNIT |
|-----------|-------------------------------|-----|------|
| $C_{pd}$  | Power dissipation capacitance | 45  | pF   |

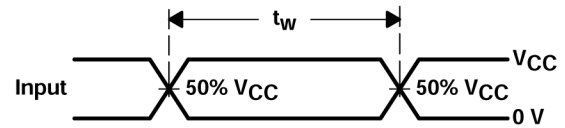
## 5 Parameter Measurement Information



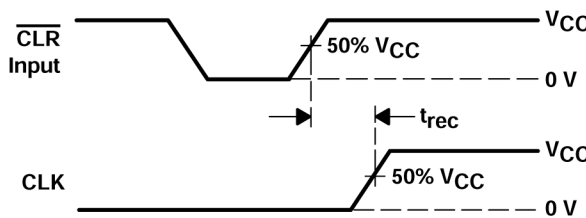
$^\dagger$  When  $V_{CC} = 1.5 \text{ V}$ ,  $R_1 = R_2 = 1 \text{ k}\Omega$

LOAD CIRCUIT

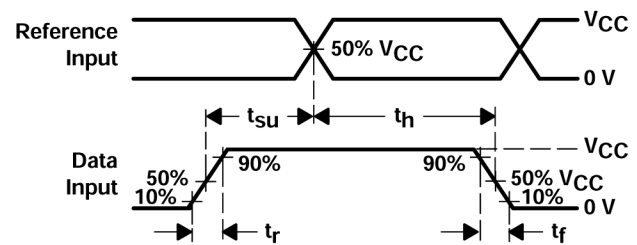
| TEST              | S1                |
|-------------------|-------------------|
| $t_{PLH}/t_{PHL}$ | Open              |
| $t_{PLZ}/t_{PZL}$ | $2 \times V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND               |



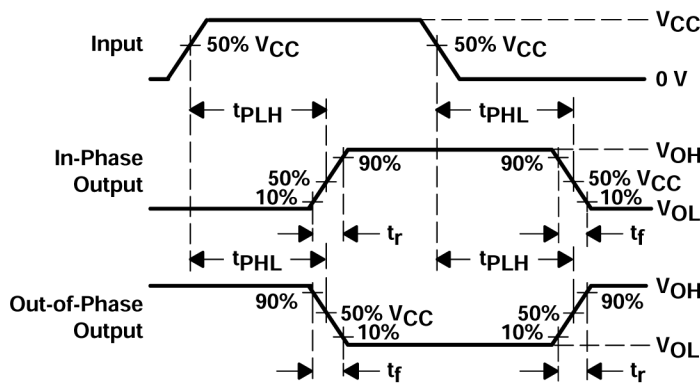
VOLTAGE WAVEFORMS  
PULSE DURATION



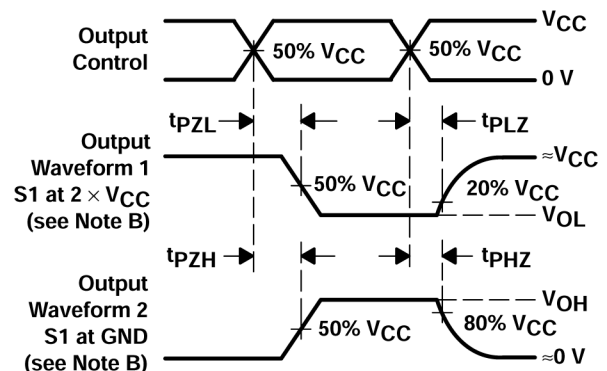
VOLTAGE WAVEFORMS  
RECOVERY TIME



VOLTAGE WAVEFORMS  
SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES



VOLTAGE WAVEFORMS  
OUTPUT ENABLE AND DISABLE TIMES

- $C_L$  includes probe and test-fixture capacitance.
- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ . Phase relationships between waveforms are arbitrary.
- For clock inputs,  $f_{max}$  is measured with the input duty cycle at 50%.
- The outputs are measured one at a time with one input transition per measurement.
- $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .

Figure 5-1. Load Circuit and Voltage Waveforms

## 6 Detailed Description

### 6.1 Functional Block Diagram



Figure 6-1. Logic Diagram, Each Gate (Positive Logic)

### 6.2 Device Functional Modes

Table 6-1. Function Table (Each Gate)

| INPUTS |   | OUTPUT Y |
|--------|---|----------|
| A      | B |          |
| H      | H | L        |
| L      | X | H        |
| X      | L | H        |

## 7 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 7.1 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the [Section 4.2](#).

Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, TI recommends a 0.1- $\mu\text{F}$  capacitor and if there are multiple  $V_{CC}$  terminals then TI recommends a 0.01- $\mu\text{F}$  or 0.022- $\mu\text{F}$  capacitor for each power terminal. Multiple bypass capacitors can be paralleled to reject different frequencies of noise. Frequencies of 0.1  $\mu\text{F}$  and 1  $\mu\text{F}$  are commonly used in parallel. The bypass capacitor should be installed as close as possible to the power terminal for best results.

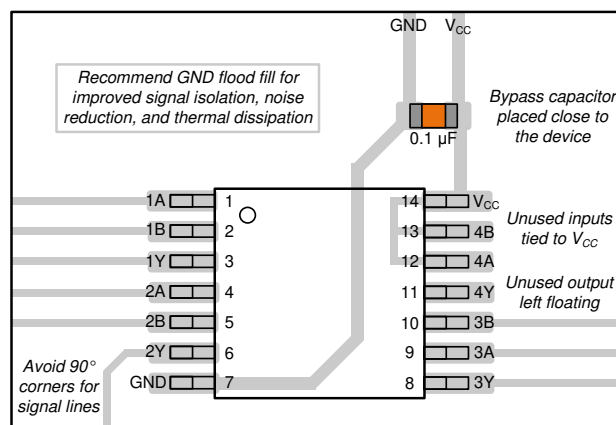
### 7.2 Layout

#### 7.2.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only three of the four buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$  whichever make more sense or is more convenient. Floating outputs is generally acceptable, unless the part is a transceiver. If the transceiver has an output enable pin it will disable the outputs section of the part when asserted. This will not disable the input section of the I.O's so they also cannot float when disabled.

#### 7.2.2 Layout Example



**Figure 7-1. Layout Example for the CDx4AC00**

## 8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 8.1 Documentation Support (Analog)

#### 8.1.1 Related Documentation

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 8-1. Related Links**

| PARTS    | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| CD54AC00 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| CD74AC00 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](https://www.ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 8.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 8.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 8.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 8.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 9 Revision History

| Changes from Revision C (June 2002) to Revision D (July 2024)                                                                                                                                                                                                                                                     | Page |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added <i>Device Information</i> table, <i>Pin Functions</i> table, <i>Thermal Information</i> table, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | 1    |
| • Updated thermal values for RθJA: D = 86 to 119.9, all values in °C/W .....                                                                                                                                                                                                                                      | 4    |

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">CD54AC00F3A</a> | Active        | Production           | CDIP (J)   14  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54AC00F3A         |
| CD54AC00F3A.A               | Active        | Production           | CDIP (J)   14  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | CD54AC00F3A         |
| <a href="#">CD74AC00E</a>   | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC00E           |
| CD74AC00E.A                 | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -55 to 125   | CD74AC00E           |
| <a href="#">CD74AC00M</a>   | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | -55 to 125   | AC00M               |
| <a href="#">CD74AC00M96</a> | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC00M               |
| CD74AC00M96.A               | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC00M               |
| CD74AC00M96G4               | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC00M               |
| CD74AC00M96G4.A             | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | AC00M               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**OTHER QUALIFIED VERSIONS OF CD54AC00, CD74AC00 :**

- Catalog : [CD74AC00](#)
- Military : [CD54AC00](#)

NOTE: Qualified Version Definitions:

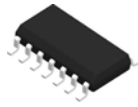
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

## TUBE

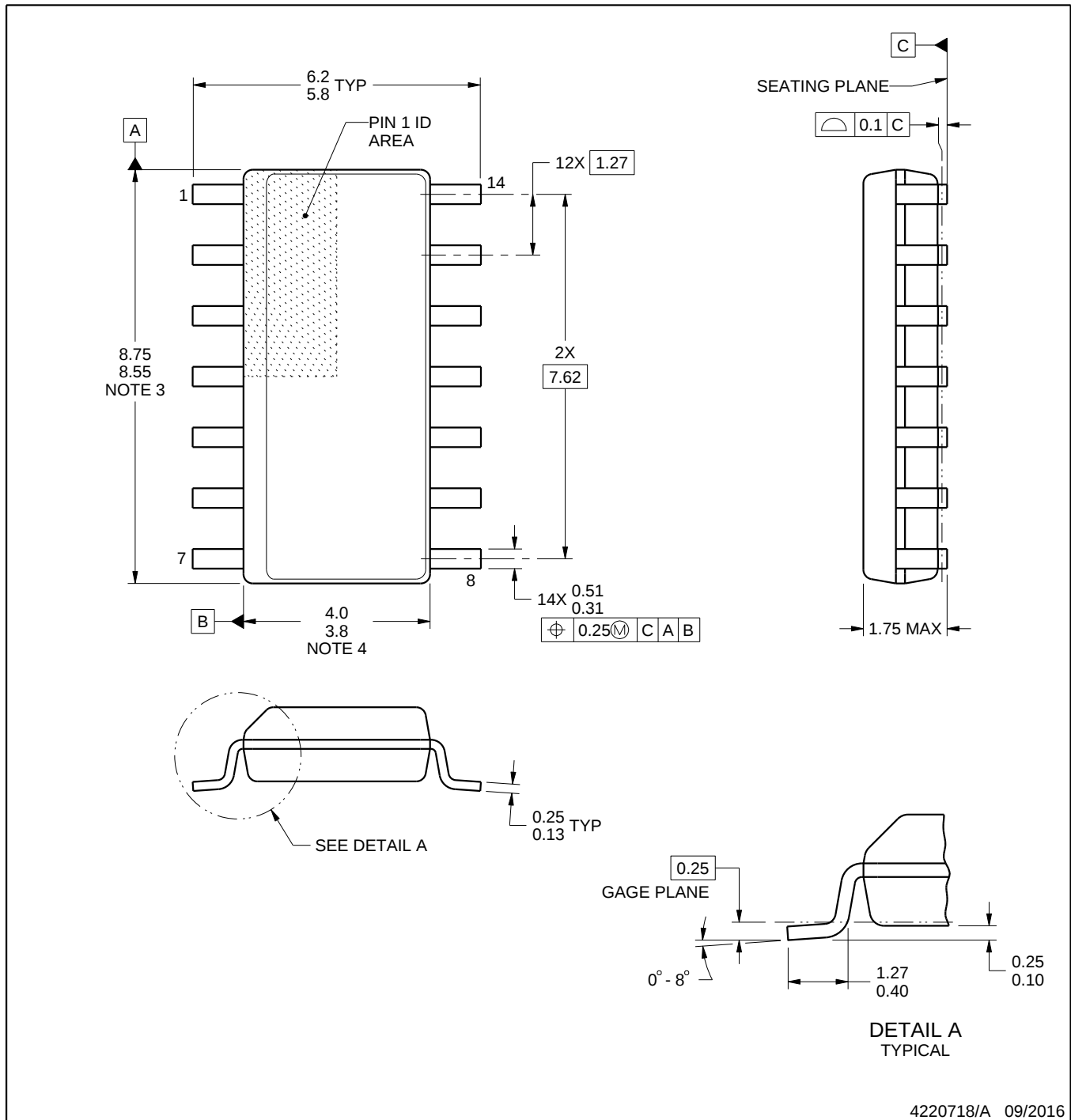


\*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74AC00E   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74AC00E   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74AC00E.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74AC00E.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



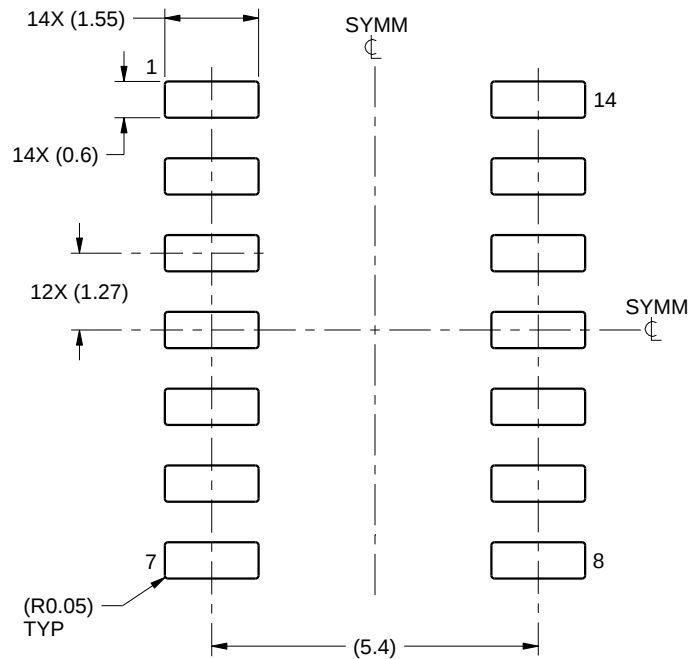
4220718/A 09/2016

# EXAMPLE BOARD LAYOUT

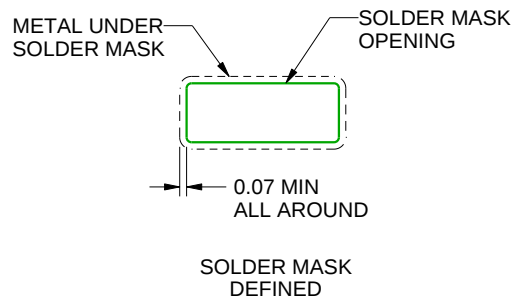
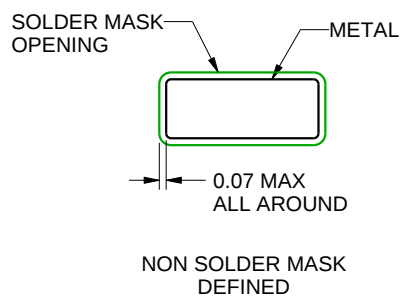
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

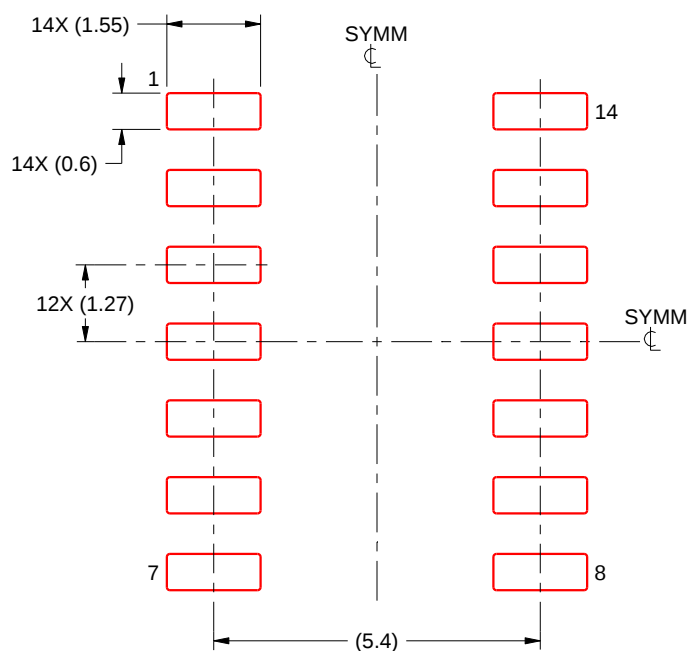
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

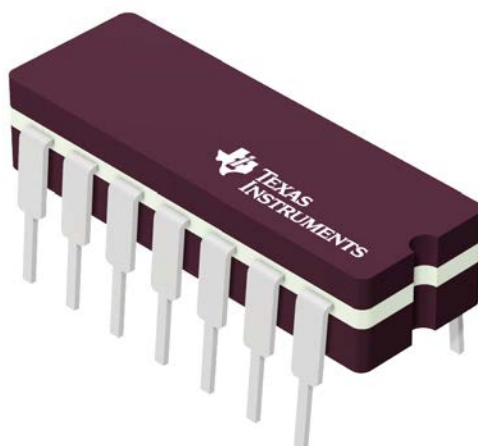
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

**J 14**

## GENERIC PACKAGE VIEW

**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

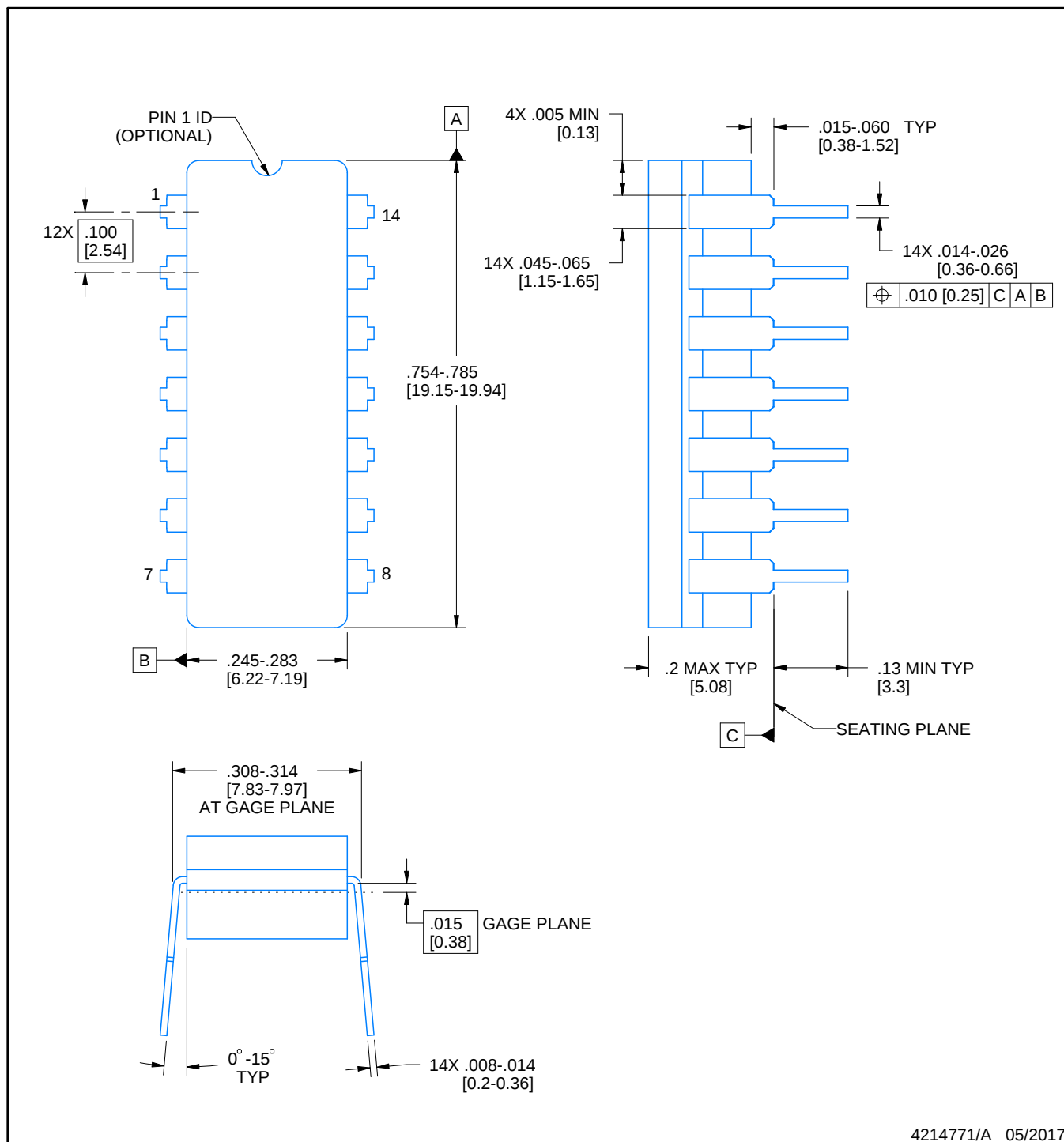


**J0014A**

## PACKAGE OUTLINE

**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



### NOTES:

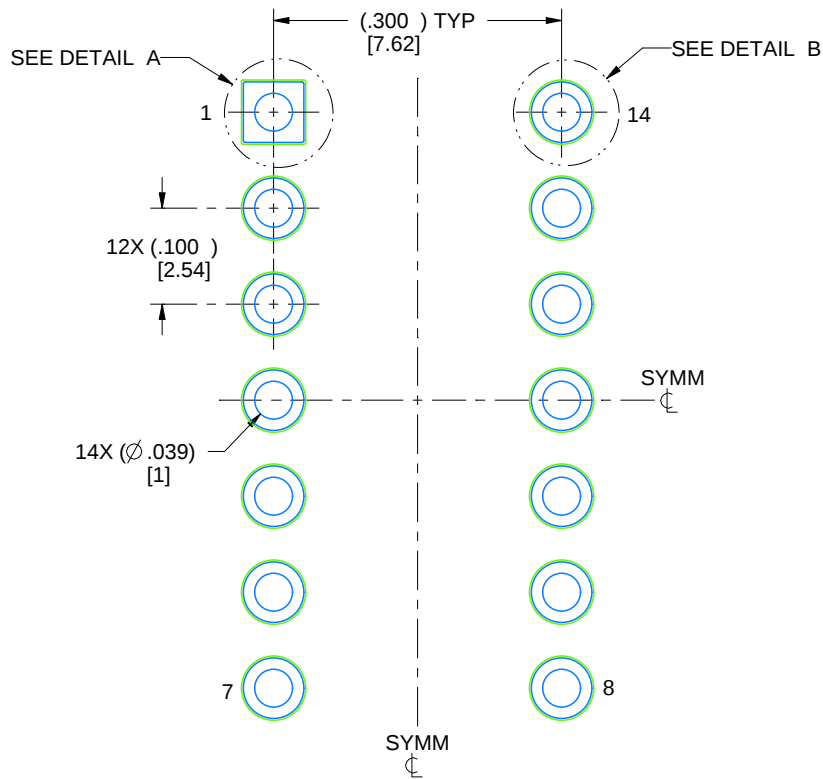
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

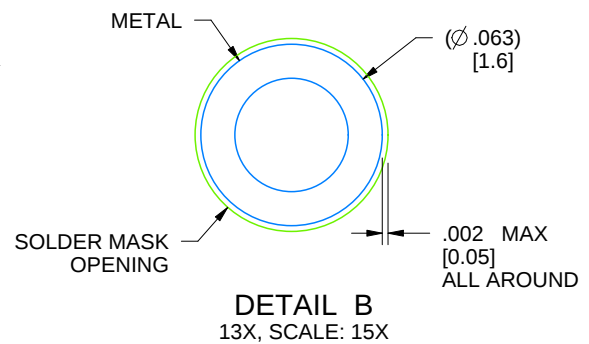
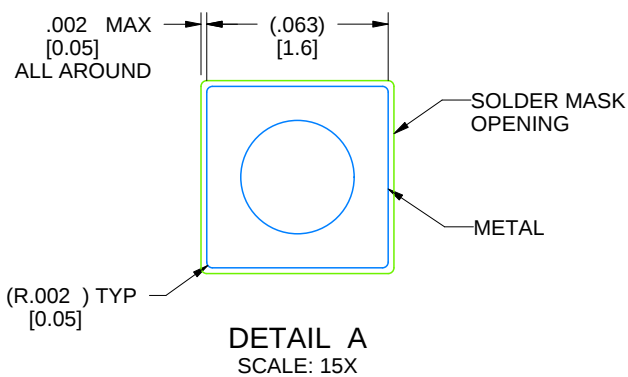
J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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